

ABSTRACT of JP 11-177199

PROBLEM TO BE SOLVED: To provide a printed wiring board constituting electronic devices and having improved reliability in electrical connection and a manufacturing method.

SOLUTION: When a via through hole 10 is made in a printed wiring board, a resin layer is made on the inner wall of the through hole and conductive paste is surely charged into the via hole. This can produce an extremely reliable via hole to prevent a disconnect in the via hole, an electrical breakdown caused by migration or the like even if a porous board is used.